

Docket No. 200308566-1  
Supporting a Circuit Package Including a Substrate  
Having a Solder Column Array

Xiang Dai et al.

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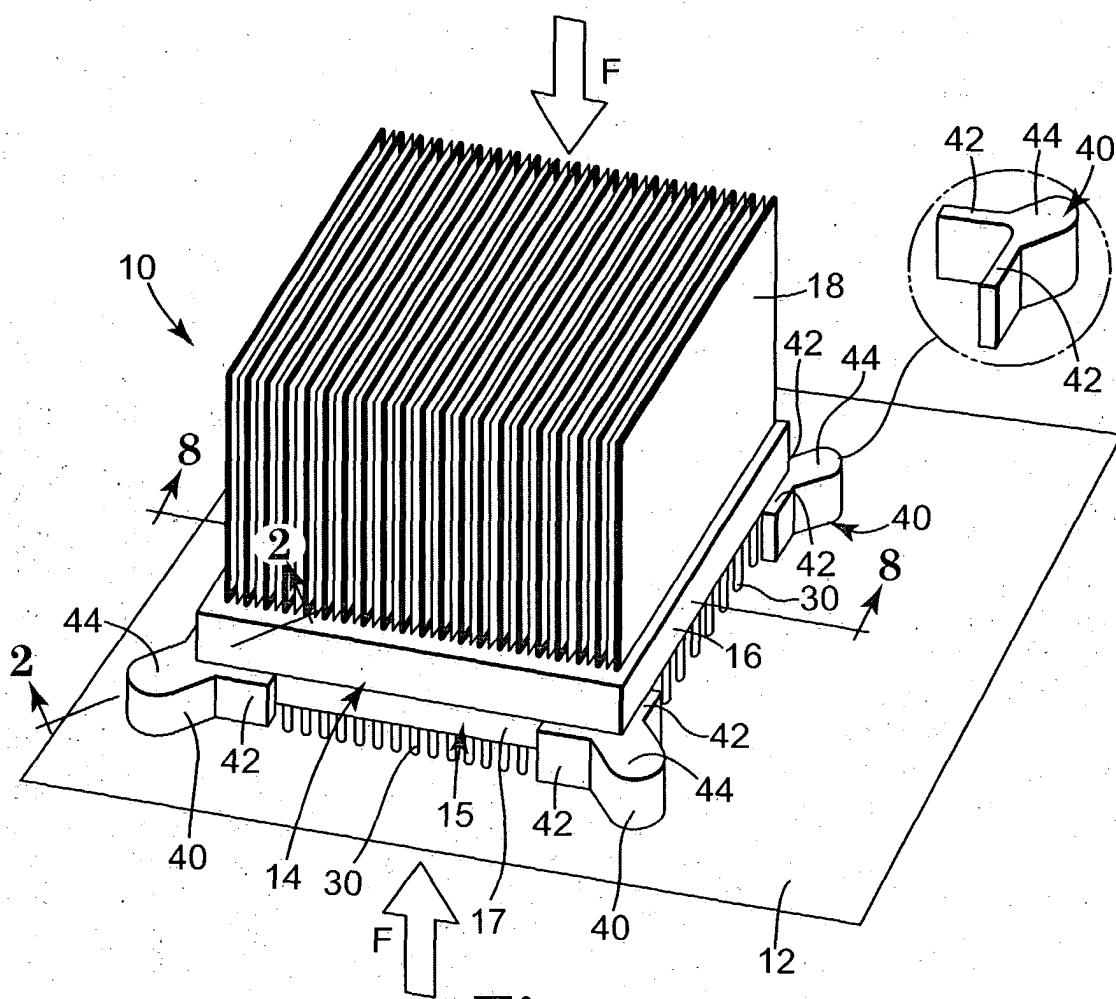


Fig. 1

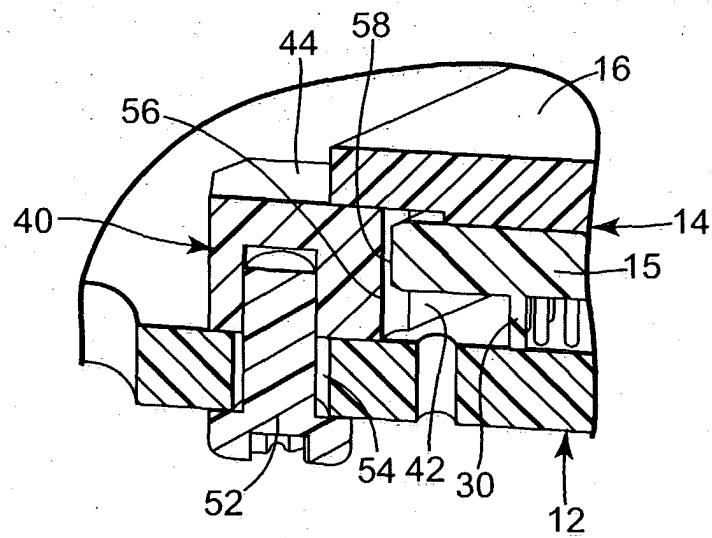


Fig. 2

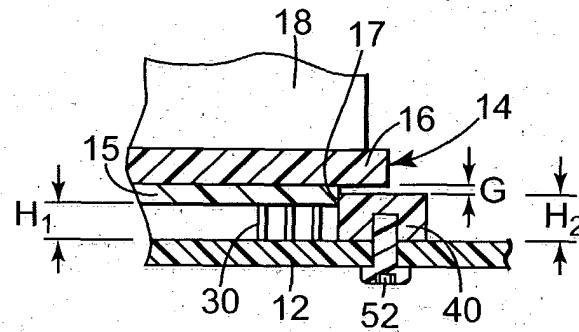


Fig. 3

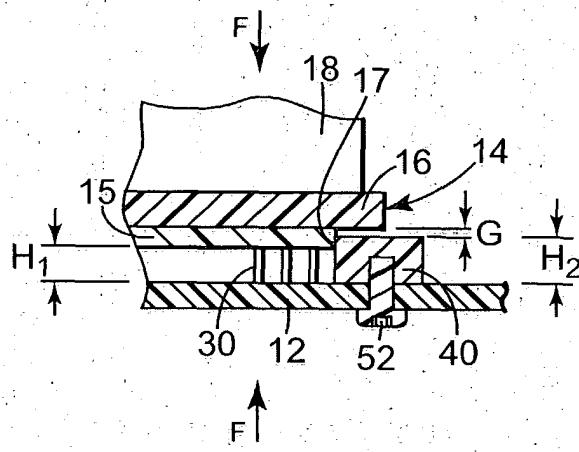


Fig. 4

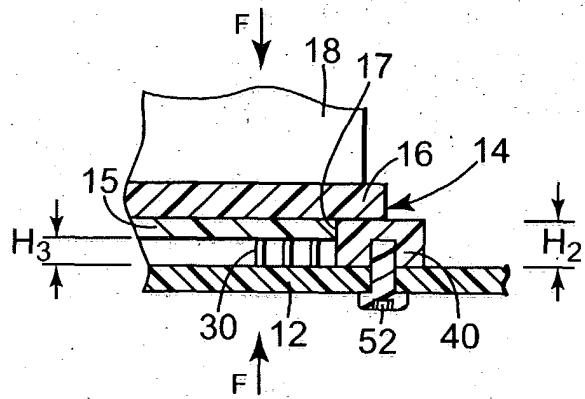


Fig. 5

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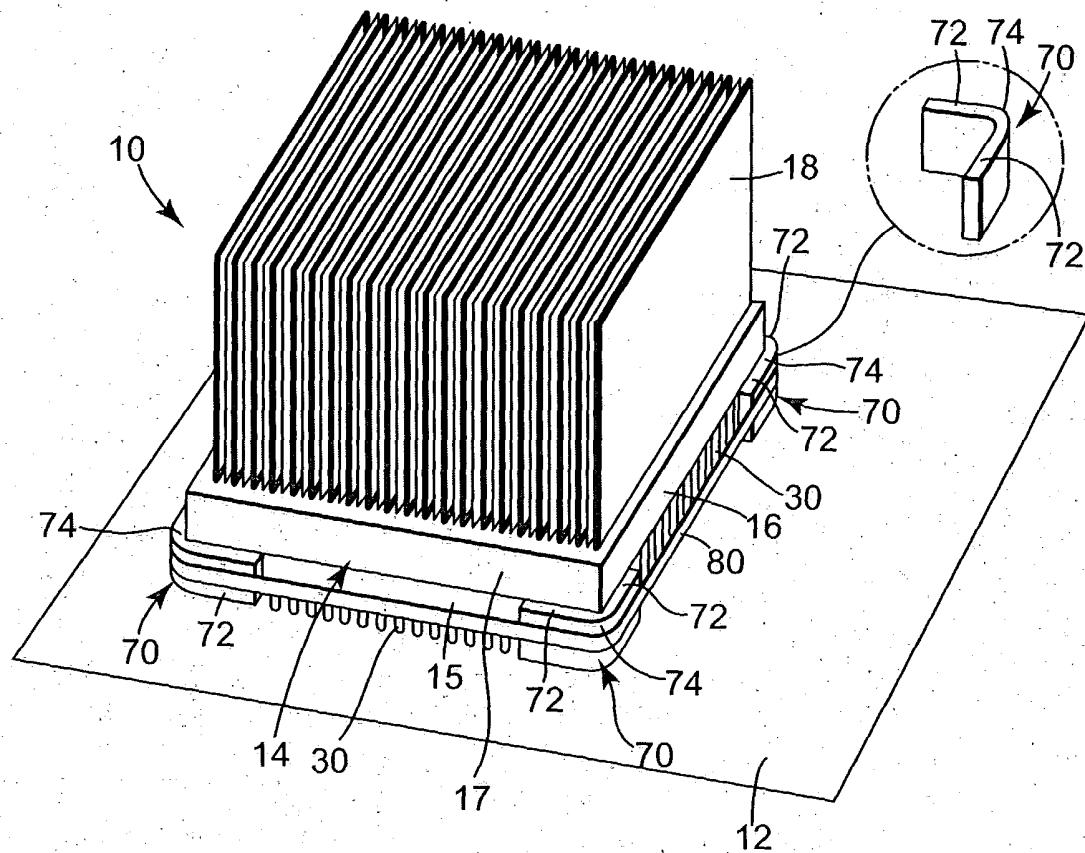


Fig. 6

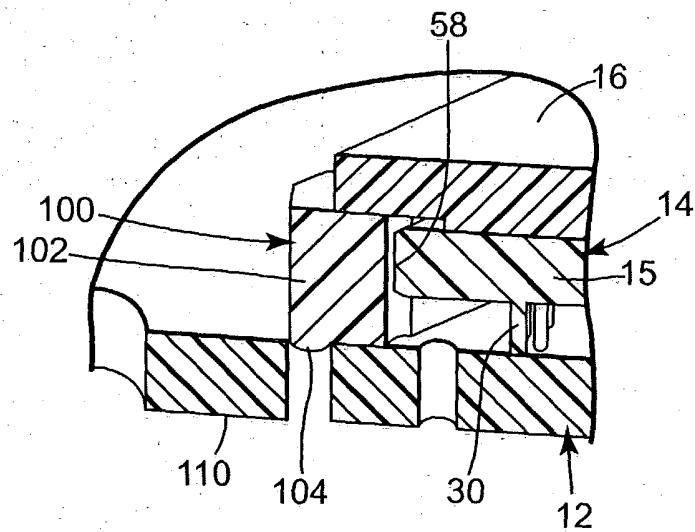


Fig. 7

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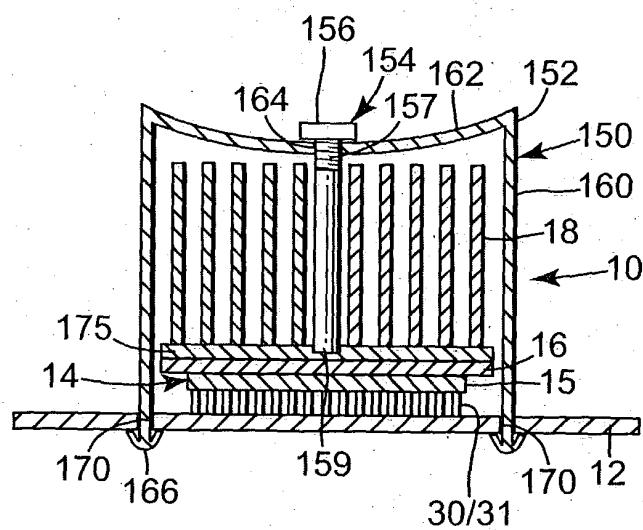


Fig. 8